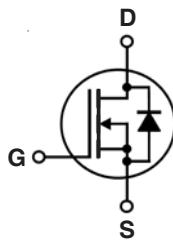


## Depletion Mode MOSFET

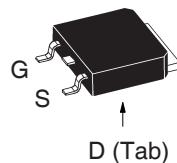
**IXTY01N100D**  
**IXTU01N100D**  
**IXTP01N100D**

**V<sub>DSX</sub> = 1000V**  
**R<sub>DS(on)</sub> ≤ 80Ω**

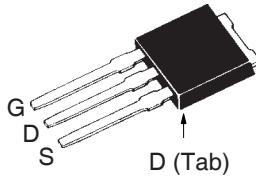
### N-Channel



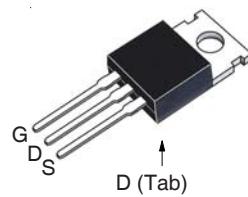
TO-252  
(IXTY)



TO-251  
(IXTU)



TO-220  
(IXTP)



G = Gate      D = Drain  
S = Source    Tab = Drain

Symbol	Test Conditions	Maximum Ratings		
V <sub>DSX</sub>	T <sub>J</sub> = 25°C to 150°C	1000		V
V <sub>DGX</sub>	T <sub>J</sub> = 25°C to 150°C	1000		V
V <sub>Gsx</sub>	Continuous	±20		V
V <sub>GSM</sub>	Transient	±30		V
I <sub>DM</sub>	T <sub>C</sub> = 25°C, Pulse Width Limited by T <sub>J</sub>	400		mA
P <sub>D</sub>	T <sub>C</sub> = 25°C	25		W
	T <sub>A</sub> = 25°C	1.1		W
T <sub>J</sub>		- 55 ... +150		°C
T <sub>JM</sub>		150		°C
T <sub>stg</sub>		- 55 ... +150		°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300		°C
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260		°C
M <sub>d</sub>	Mounting Torque (TO-220)	1.13 / 10		Nm/lb.in.
Weight	TO-252	0.35		g
	TO-251	0.40		g
	TO-220	3.00		g

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV <sub>DSX</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = 25µA	1000		V
V <sub>GS(off)</sub>	V <sub>DS</sub> = 25V, I <sub>D</sub> = 25µA	- 2.0		- 4.5 V
I <sub>Gsx</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100 nA
I <sub>DSX(off)</sub>	V <sub>DS</sub> = V <sub>DSX</sub> , V <sub>GS</sub> = -10V T <sub>J</sub> = 125°C			10 µA 250 µA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 50mA, Note 1	50	80	Ω
I <sub>D(on)</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, Note 1	400		mA

### Features

- Normally ON Mode
- International Standard Packages
- Low R<sub>DS(on)</sub> HDMOS™ Process
- Rugged Polysilicon Gate Cell Structure
- Fast Switching Speed

### Advantages

- Easy to Mount
- Space Savings
- High Power Density

### Applications

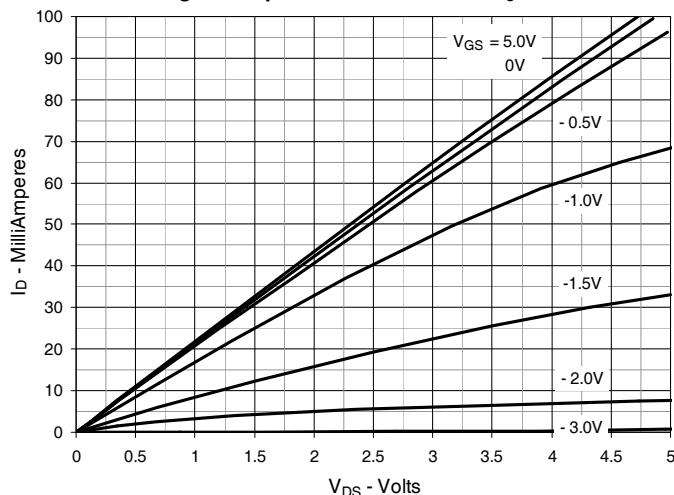
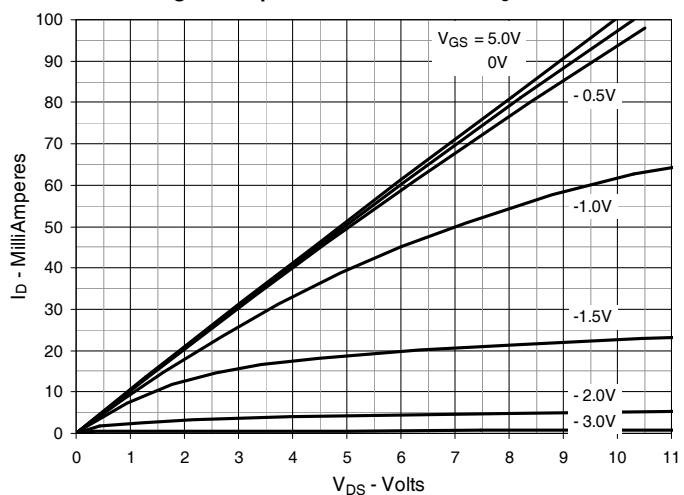
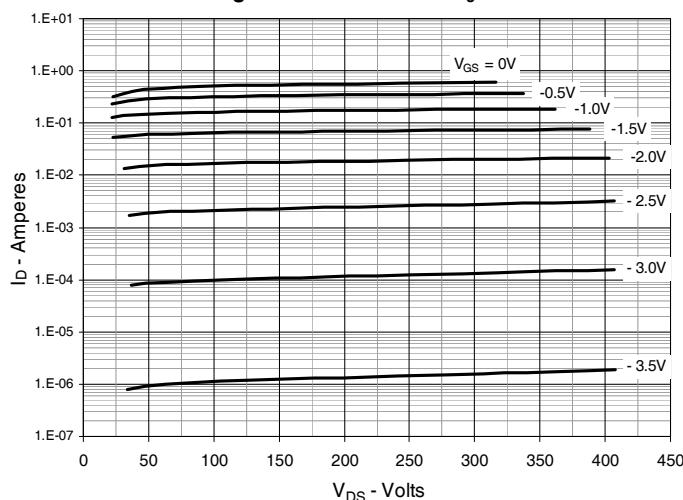
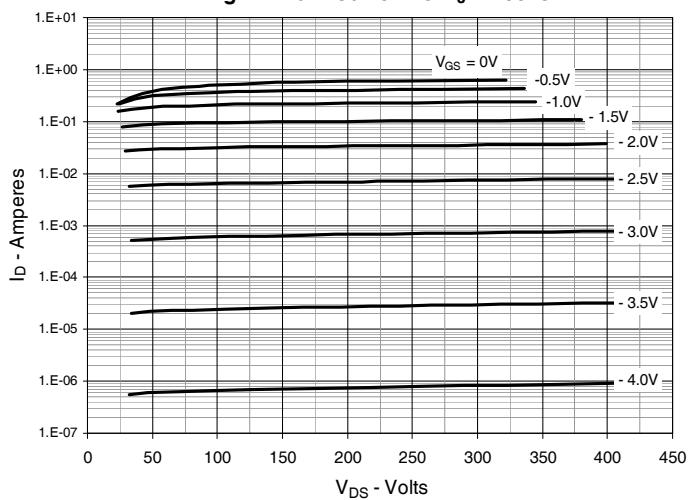
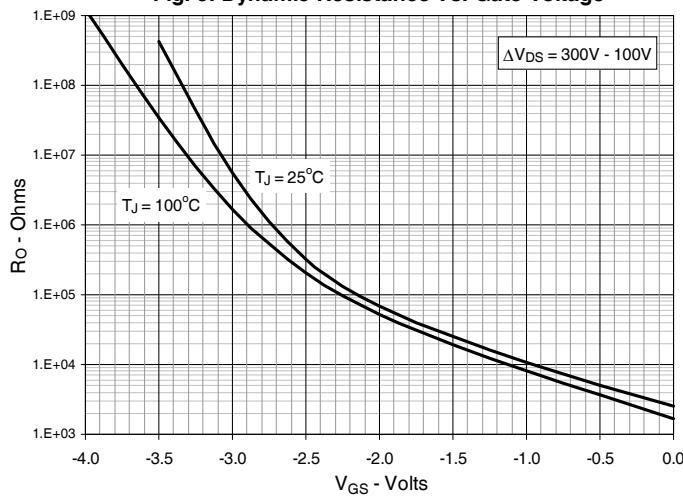
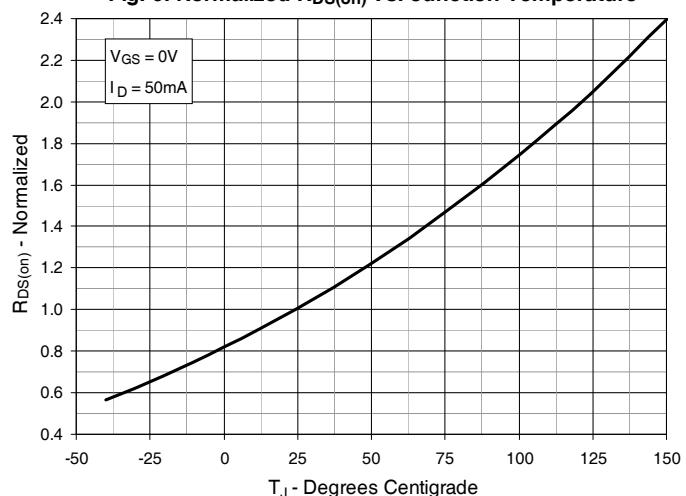
- Level Shifting
- Triggers
- Solid State Relays
- Current Regulators

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 100V, I_D = 100mA$ , Note 1	100	200	mS
$C_{iss}$	$V_{GS} = -10V, V_{DS} = 25V, f = 1MHz$	100	pF	
$C_{oss}$		12	pF	
$C_{rss}$		2	pF	
$t_{d(on)}$	<b>Resistive Switching Times</b> $V_{GS} = \pm 5V, V_{DS} = 50V, I_D = 50mA$ $R_G = 30\Omega$ (External)	7	ns	
$t_r$		10	ns	
$t_{d(off)}$		34	ns	
$t_f$		64	ns	
$Q_{g(on)}$	$V_{GS} = \pm 5V, V_{DS} = 500V, I_D = 50mA$	5.8	nC	
$Q_{gs}$		3.6	nC	
$Q_{gd}$		0.4	nC	
$R_{thJC}$	TO-220	0.50	5.0	°C/W
$R_{thCS}$			0.50	°C/W

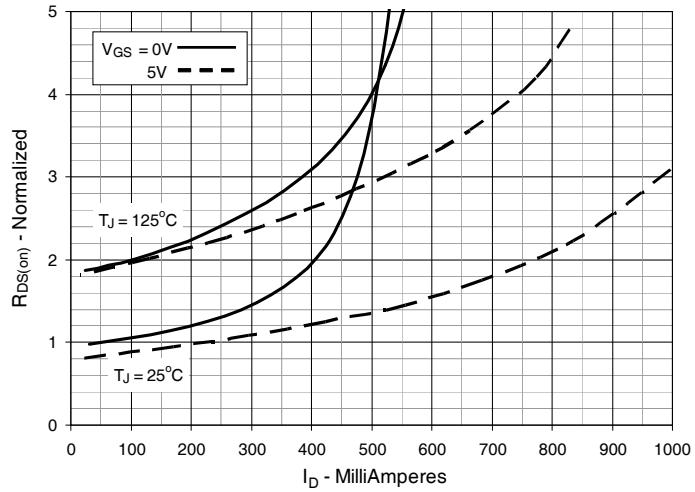
### Source-Drain Diode

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$V_{SD}$	$I_F = 100mA, V_{GS} = -10V$ , Note 1		1.5	V
$t_{rr}$	$I_F = 750mA, -di/dt = 100A/\mu s$ $V_R = 25V, V_{GS} = -10V$		1.5	μs

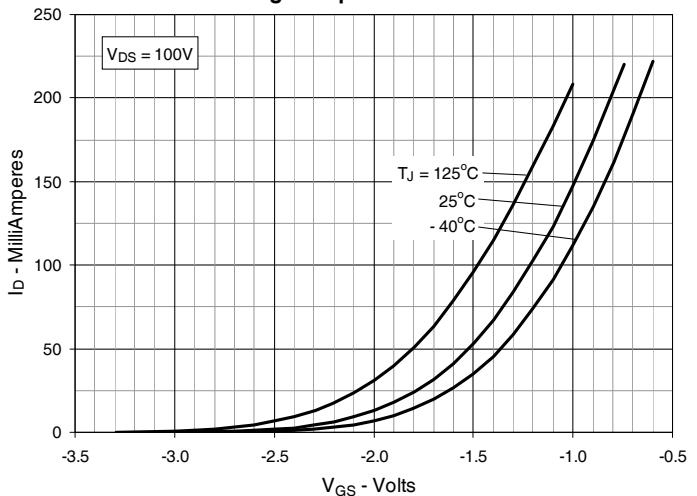
Note 1. Pulse test,  $t \leq 300\mu s$ , duty cycle,  $d \leq 2\%$ .

**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 2. Output Characteristics @  $T_J = 125^\circ\text{C}$** 

**Fig. 3. Drain Current @  $T_J = 25^\circ\text{C}$** 

**Fig. 4. Drain Current @  $T_J = 100^\circ\text{C}$** 

**Fig. 5. Dynamic Resistance vs. Gate Voltage**

**Fig. 6. Normalized  $R_{DS(on)}$  vs. Junction Temperature**


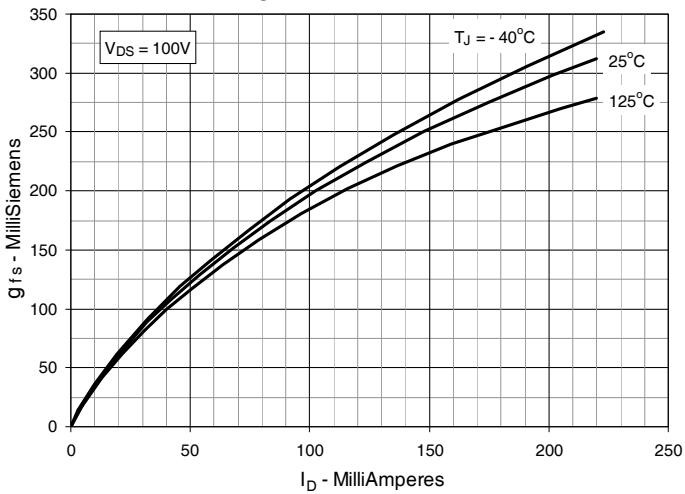
**Fig. 7.  $R_{DS(on)}$  Normalized to  $I_D = 50\text{mA}$  Value vs. Drain Current**



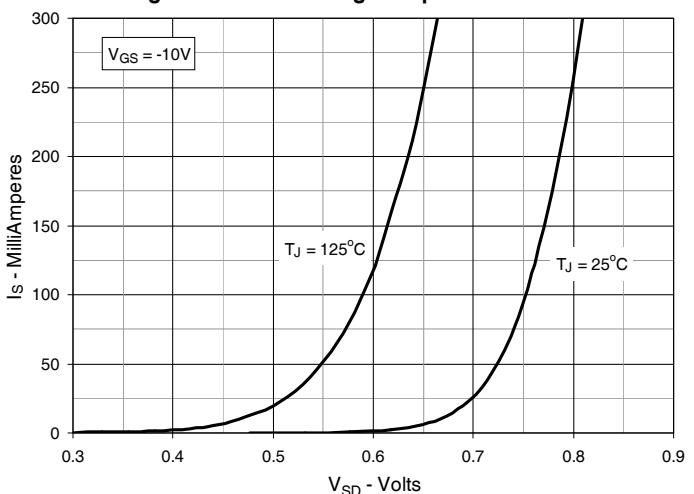
**Fig. 8. Input Admittance**



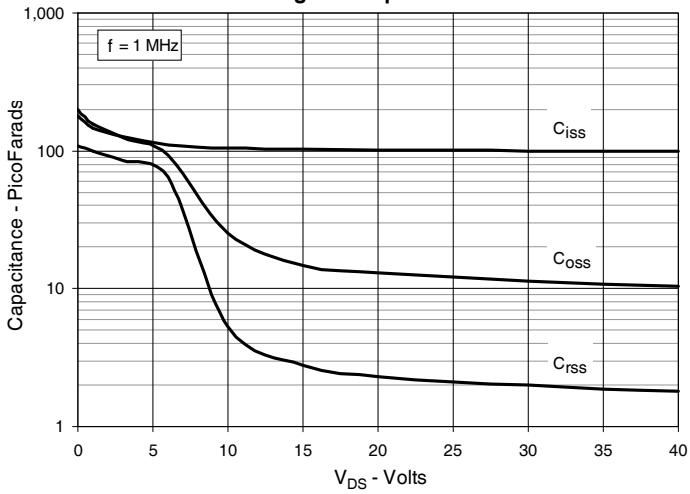
**Fig. 9. Transconductance**



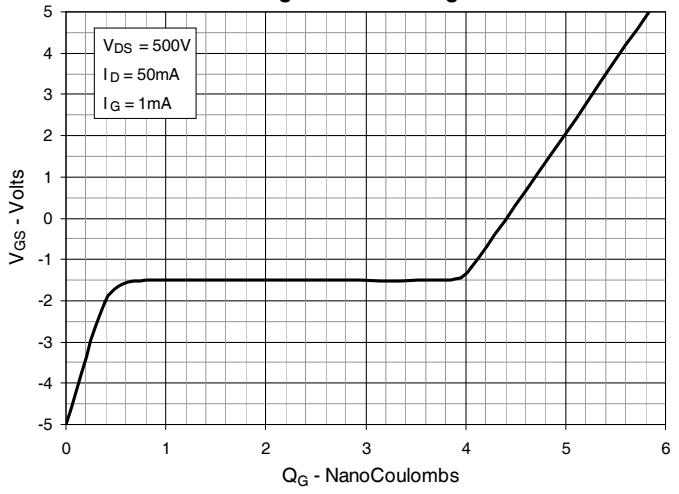
**Fig. 10. Forward Voltage Drop of Intrinsic Diode**



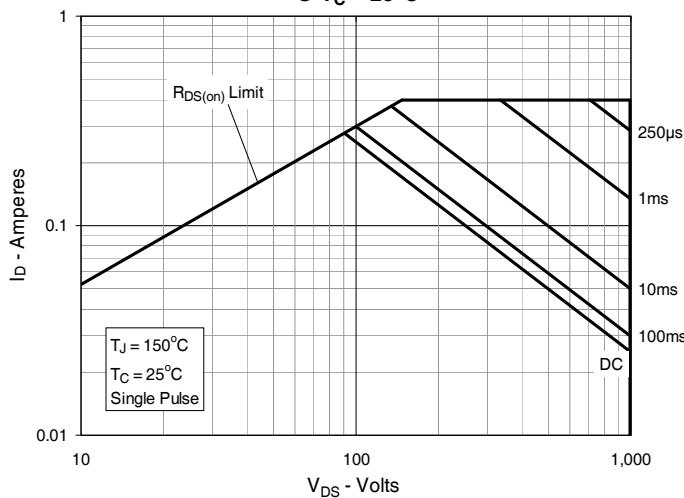
**Fig. 11. Capacitance**



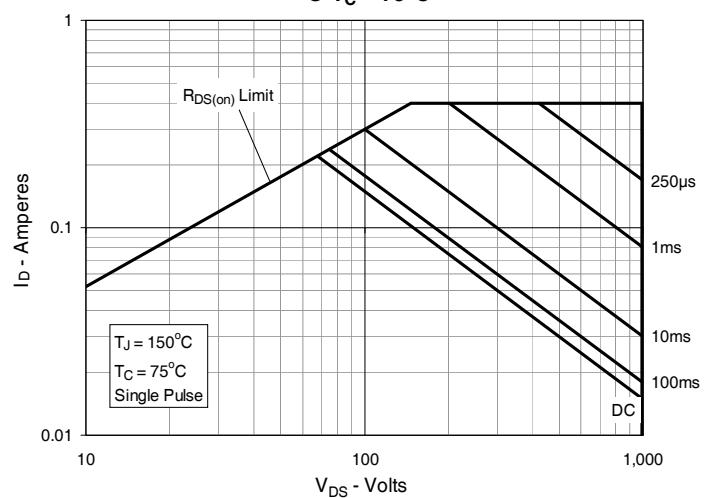
**Fig. 12. Gate Charge**



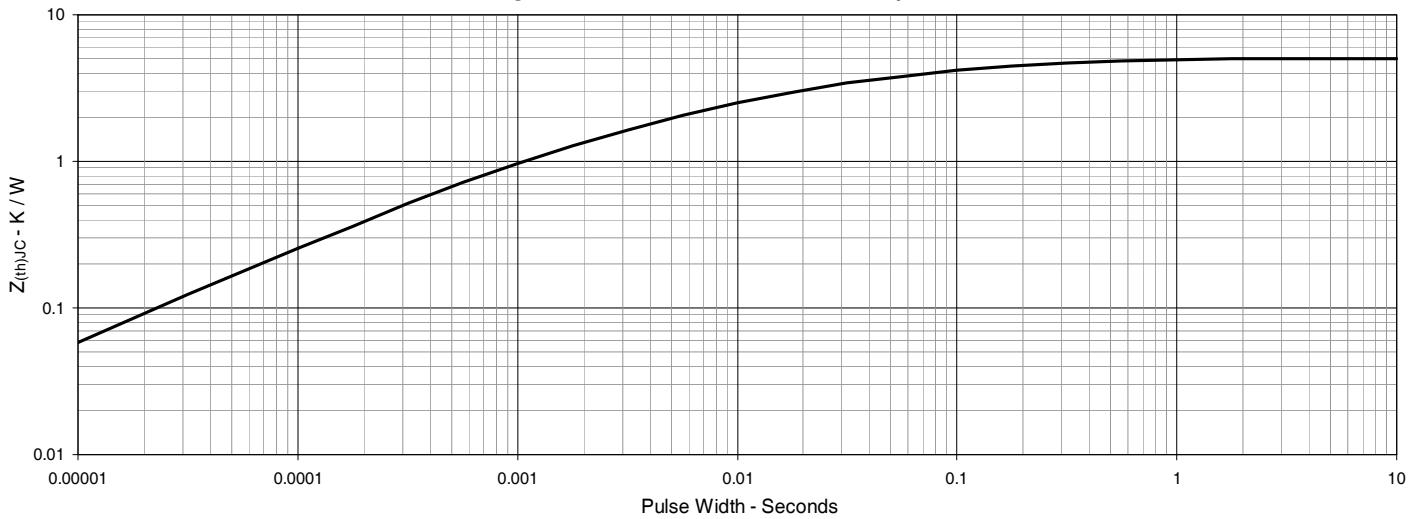
**Fig. 13. Forward-Bias Safe Operating Area  
@  $T_C = 25^\circ\text{C}$**



**Fig. 14. Forward-Bias Safe Operating Area  
@  $T_C = 75^\circ\text{C}$**



**Fig. 15. Maximum Transient Thermal Impedance**



TO-252 Outline		INCHES				MILLIMETERS			
SYM		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A	.086	.094		2.19		2.38			
A1	0	.005		0		0.12			
A2	.038	.046		0.97		1.17			
b	.025	.035		0.64		0.89			
b2	.030	.045		0.76		1.14			
b3	.200	.215		5.08		5.46			
c	.018	.024		0.46		0.61			
c2	.018	.023		0.46		0.58			
D	.235	.245		5.97		6.22			
D1	.180	.205		4.57		5.21			
E	.250	.265		6.35		6.73			
E1	.170	.205		4.32		5.21			
e	.090 BSC			2.28 BSC					
e1	.180 BSC			4.57 BSC					
H	.370	.410		9.40		10.42			
L	.055	.070		1.40		1.78			
L1	.100	.115		2.54		2.92			
L2	.020 BSC			0.50 BSC					
L3	.025	.040		0.64		1.02			
L4	.025	.040		0.64		1.02			
<b>θ</b>	0°	10°		0°		10°			

NOTE: 1. This drawing comply JEDEC TO-252AA value except L3 dimension.  
2. All metal surface are tin plated except trimmed area.

TO-251 Outline		INCHES				MILLIMETERS			
SYM		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A	.087	.094		2.20		2.40			
A1	.032	.048		0.82		1.22			
b	.026	.034		0.66		0.86			
(b2)	.030	.038		0.76		0.96			
b4	.198	.222		5.04		5.64			
c	.018	.024		0.45		0.60			
c2	.016	.024		0.40		0.60			
D	.232	.248		5.90		6.30			
(D1)	.179	.195		4.55		4.95			
E	.252	.268		6.40		6.80			
(E1)	.191	.207		4.85		5.25			
e	.090 BSC			2.28 BSC					
e1	.180 BSC			4.57 BSC					
L	.358	.374		9.10		9.50			
L1	.063	.079		1.60		2.00			
L2	.020	.035		0.50		0.90			

NOTE: 1. ALL METAL AREA ARE MATTE PURE TIN PLATED EXCEPT TRIMMED AREA.  
2. THESE DIMENSIONS DO NOT INCLUDE PROTRUSIONS OF THE MOLD.  
3. THE ( ) MARK IS THE REFERENCE ONLY.

TO-220 Outline		INCHES				MILLIMETERS			
SYM		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A	.169	.185		4.30		4.70			
A1	.047	.055		1.20		1.40			
A2	.079	.106		2.00		2.70			
b	.024	.039		0.60		1.00			
b2	.045	.057		1.15		1.45			
c	.014	.026		0.35		0.65			
D	.587	.626		14.90		15.90			
D1	.335	.370		8.50		9.40			
(D2)	.500	.531		12.70		13.50			
E	.382	.406		9.70		10.30			
(E1)	.283	.323		7.20		8.20			
e	.100 BSC			2.54 BSC					
e1	.200 BSC			5.08 BSC					
H1	.244	.268		6.20		6.80			
L	.492	.547		12.50		13.90			
L1	.110	.154		2.80		3.90			
ØP	.134	.150		3.40		3.80			
Q	.106	.126		2.70		3.20			

NOTE:

- All metal surface are matte pure tin plated except trimmed area.